

Heat Sink



Specification

MST-DFI-DK

Exceptional Heat Dissipation

For DFI Mosfet

- 1. Material: CU 1100
- 2. Dimension:
 - Foot print: 63.5*16 mm
 - Height: 29.6 mm
 - Base(thickness): 2.6 mm
- 3. Finsh: Redox



Performance

| | |
|-------------------|-------|
| Heat Source (L*W) | 48*11 |
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